



Product Change Notification

102545 - 00

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Change Notification #: # 102545 - 00
Change Title: Intel® 845G, PCN 102545-00,
FFF, 845G A1 to 845G B1
Stepping Conversion
Date of PCN Publication: Thursday, September 26, 2002

Type of Change Notification:
Form-Fit-Function

Key Characteristics of the Change:
Product Design

Forecasted Key Milestones:

Date of Samples Availability:	Nov 04, 2002
Date of Qualification Data Availability:	Dec 23, 2002
Date Customer Must be Ready to Receive Post-Conversion Material:	Jan 06, 2003
Date of First Availability of Post-Conversion Material:	Jan 06, 2003

The date of "First Availability of Post-Conversion Material" is the projected date that a customer may expect to receive the Post-Conversion Materials. This date is determined by the projected depletion of inventory at the time of the PCN publication. The depletion of inventory may be impacted by fluctuating supply and demand, therefore, although customers should be prepared to receive the Post-Converted Materials on this date, Intel will continue to ship and customers may continue to receive the pre-converted materials until the inventory has been depleted.

Description of Change to the Customer:

The Intel® 845G chipset component is converting from A1 to B1 stepping.

For technical details of the Intel® 845G chipset component, please refer to the latest Spec Update available on FDBL.

Customer Impact of Change and Recommended Action:

The 845G B1 is pin-to-pin compatible with the A1 and does not require any motherboard modifications. Design changes have been made to the 845G B1 and will require customers to perform re-qualification. Please see the 845G B1 spec update for any BIOS changes required.

**Products Affected / Intel Ordering Codes:
Component Products Table**

Pre-conversion Product Code	Pre-conversion Spec/ROM	Pre-conversion MM#	Post-conversion Product Code	Post-conversion Spec/ROM	Post-conversion MM#
RG82845G	S L66F	845246	RG82845G RG82845G	Q D71 S L6PR	850153 850147

Reference Documents / Attachments:

Document:

Location #:

PCN Revision History:

Date of Revision:

Revision Number:

Reason:

Sep 26, 2002

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Originally Published PCN